MPQ4475



36V, 2.5A, Frequency Selectable, Step-Down Converter with Single USB Charging Port AEC-Q100 Qualified

DESCRIPTION

The MPQ4475 integrates a monolithic, step-down, switch-mode converter with a single USB current-limit switch and a charging port identification circuit. The MPQ4475 achieves 2.5A of continuous output current with excellent load and line regulation over a wide input supply range.

The output of the USB switch is current-limited. The MPQ4475 provides a USB-dedicated charging port (DCP), which supports battery charging specification 1.2 (BC1.2), divider mode, and 1.2V/1.2V mode without the need for outside user interaction. The output voltage has programmable line drop compensation.

Full protection features include hiccup current limiting, output over-voltage protection (OVP), and thermal shutdown.

The MPQ4475 requires a minimal number of readily available, standard, external components and is available in a QFN-25 (4mmx4mm) package.

FEATURES

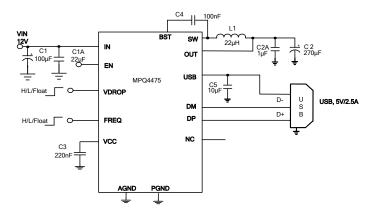
- Wide 7V to 36V Operating Input Voltage Range
- Fixed 5V Output Voltage with Line Drop Compensation
- Accurate USB Output Current Limit
- 40mΩ/32mΩ Low R_{DS(ON)} Internal Buck Power MOSFETs
- 24mΩ Low R_{DS(ON)} Internal USB Power MOSFET
- 350kHz / 250kHz / 150kHz Frequency Selectable
- Programmable Line Drop Compensation
- Output Over-Voltage Protection (OVP)
- Hiccup Current Limit
- Supports DCP Scheme for BC1.2, Divider Mode, and 1.2V/1.2V Mode
- ±8kV HBM ESD Rating for USB, DP, and DM Pins
- Less than One Second of Short-Circuit Recovery (Hiccup Mode Off Time)
- Available in a QFN-25 (4mmx4mm) Package
- Available in AEC-Q100 Grade 1

APPLICATIONS

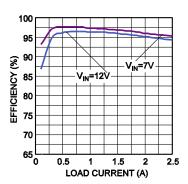
Automotive USB Smart Charging Ports

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TYPICAL APPLICATION



Efficiency vs. Load Current





ORDERING INFORMATION

Part Number*	Package	Top Marking	
MPQ4475GR-AEC1	QFN-25 (4mmx4mm)	See Below	

^{*} For Tape & Reel, add suffix -Z (e.g.: MPQ4475GR-Z).

TOP MARKING

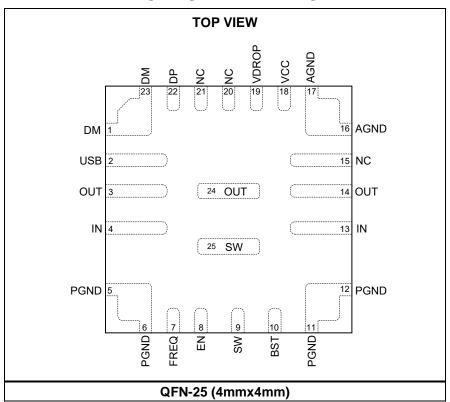
MPSYWW MP4475 LLLLLL

MPS: MPS prefix Y: Year code WW: Week code

MP4475: Product code of MPQ4475GR-AEC1

LLLLL: Lot number

PACKAGE REFERENCE





ABSOLUTE MAXIMUM RA	ATINGS (1)
Supply voltage (V _{IN})	
V _{SW} 0.3V (-	
to $V_{IN} + 0.3V$ (43)	3V for <10ns)
V_{BST}	V_{SW} + 6.5 V
Ven0	.3V to 10V ⁽²⁾
All other pins(0.3V to +6.5V
Continuous power dissipation (T _A =	= +25°C) ⁽³⁾
QFN-25 (4mmx4mm)	2.8W
Junction temperature	150°C
Lead temperature	260°C
Storage temperature65	°C to +150°C
Recommended Operating Cor	nditions ⁽⁴⁾
Operation input voltage range	
Output current	

Operating junction temp. (T_J)... -40°C to +125°C

Thermal Resistance ⁽⁵⁾	$oldsymbol{ heta}_{JA}$	$\boldsymbol{\theta}$ JC	
QFN-25 (4mmx4mm)	44	9	°C/W

NOTES:

- 1) Exceeding these ratings may damage the device.
- For details of EN's ABS max rating, please refer to the EN Control section on page 11.
- 3) The maximum allowable power dissipation is a function of the maximum junction temperature T_J (MAX), the junction-to-ambient thermal resistance θ_{JA} , and the ambient temperature $T_A.$ The maximum allowable continuous power dissipation at any ambient temperature is calculated by P_D (MAX) = $(T_J$ (MAX)- T_A)/ θ_{JA} . Exceeding the maximum allowable power dissipation produces an excessive die temperature, causing the regulator to go into thermal shutdown. Internal thermal shutdown circuitry protects the device from permanent damage.
- The device is not guaranteed to function outside of its operating conditions.
- 5) Measured on JESD51-7, 4-layer PCB.



ELECTRICAL CHARACTERISTICS

 V_{IN} = 12V, V_{EN} = 5V, T_J = -40°C to +125°C, typical value is tested at T_J = +25°C, unless otherwise noted.

Parameter	Symbol	Condition	Min	Тур	Max	Units
Cupply ourroat (aboutdons)		V _{EN} = 0V, T _J = +25°C			1	^
Supply current (shutdown)	I _{IN}	V _{EN} = 0V, T _J = -40°C to +125°C			5	μA
Supply current (quiescent)	I _{Q_OL}	No switching		1.6	2.5	mA
EN rising threshold	V _{EN_Rising}		1.33	1.43	1.52	V
EN hysteresis	V _{EN_Falling}		110	140	170	mV
		$V_{EN} = 2V, T_J = +25^{\circ}C$	1.1	1.8	2.5	
EN input current	I _{EN}	$V_{EN} = 2V$, $T_J = -40$ °C to $+125$ °C	0.8	1.8	3	μA
		V _{EN} = 0V		0		
Thermal shutdown (6)	T _{STD}			165		°C
Thermal hysteresis (6)	T _{STD_HYS}			20		°C
VCC regulator	Vcc		4.75	5.1	5.45	V
VCC load regulation	Vcc_log	Icc = 5mA		1	2	%
Step-Down Converter						
V _{IN} under-voltage lockout threshold rising	V _{IN_UVLO}	T _J = +25°C	5.2	5.7	6.2	V
V _{IN} under-voltage lockout threshold hysteresis	Vuvlo_hys			1		V
HS switch on resistance	R _{DS(ON)_HS}			40		mΩ
LS switch on resistance	R _{DS(ON)_LS}			32		mΩ
		$7V < V_{IN} < 36V$, no load, $T_J = +25$ °C	5	5.05	5.1	
Output voltage	Vоит	$7V < V_{IN} < 36V$, no load, $T_J = -40^{\circ}C$ to $+125^{\circ}C$	4.95	5.05	5.15	V
Output over-voltage protection	V _{OVP_R}		5.65	6	6.4	٧
OVP recovery	V _{OVP_F}	$T_J = -40^{\circ}\text{C to } +125^{\circ}\text{C}$	5.4	5.75	6.1	V
		V _{EN} = 0V, V _{SW} = 36V, T _J = +25°C			1	
Switch leakage	SWLKG	$V_{EN} = 0V$, $V_{SW} = 36V$, $T_J = -40$ °C to $+125$ °C			5	μA
Current limit (6)	ILIMIT	Over 0 - 90% duty cycle	4			Α
Oscillator frequency	f _{SW1}	FREQ = high, T _J = +25°C	310	350	410	- kHz
		FREQ = high, T_J = -40°C to +125°C	300	350	420	
	f _{SW2}	FREQ = low, T _J = +25°C	220	250	300	
		FREQ = low, T _J = -40°C to +125°C	190	250	330	
	f _{SW3}	FREQ = float, T _J = +25°C	125	150	180	
		FREQ = float, T _J = -40°C to +125°C	110	150	185	
Maximum duty cycle	D _{MAX}	FREQ = 350kHz	84	88		%
Minimum on time (6)	T _{ON_MIN}	T _J = +25°C		130		ns
	_	Output from 10% to 90%, T _J = +25°C	1	1.65	2.3	
Soft-start time	tss	Output from 10% to 90%, T _J = -40°C to +125°C	0.9	1.65	2.4	ms



ELECTRICAL CHARACTERISTICS (continued) $V_{IN} = 12V$, $V_{EN} = 5V$, $T_J = -40$ °C to +125°C, typical value is tested at $T_J = +25$ °C, unless otherwise noted.

Parameter	Symbol	Condition	Min	Тур	Max	Units
USB Switch					•	
Under-voltage lockout	Vusb_uvr	T _J = +25°C	3.8	4	4.3	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \
threshold rising		$T_J = -40^{\circ}\text{C to } +125^{\circ}\text{C}$	3.75	4	4.33	V
Under-voltage lockout threshold hysteresis	Vusb_uvhys		220	270	320	mV
Switch-on resistance	RDSON_SW			24		mΩ
Current limit	I _{Limit}	T _J = +25°C	2.6	2.75	2.9	Α
	V _{DROP_COM1}	Max load 2.4A, VDROP = float, T _J = +25°C	300	400	500	mV
Line drop compensation	V _{DROP_COM2}	Max load 2.4A, VDROP = high		280		mV
	V _{DROP_COM3}	Max load 2.4A, VDROP = GND		130		mV
FREQ, VDROP high level	V _{HIGH}		VCC - 0.4V			V
FREQ, VDROP middle level	VMIDDLE			2.5		V
FREQ, VDROP low level	V _{LOW}				0.4	V
	Tss	V _{OUT} = 5V, from 10% to 90%, T _J = +25°C	1	1.6	2.2	- ms
V _{BUS} soft-start time		V _{OUT} = 5V, from 10% to 90%, T _J = -40°C to +125°C	0.9	1.6	2.4	
Diagharga registance	В	T _J = +25°C		50	70	Ω
Discharge resistance	R _{DCHG}	T _J = -40°C to +125°C		50	75	
	THICP_ON1	V _{OUT} = 5V, V _{BUS} connected to GND		3 ⁽⁶⁾		- ms
On time of hiccup mode	THICP_ON2	$V_{OUT} = 5V$, $V_{BUS} > 2V$, OC , $T_{J} = +25$ °C	3.5	5	6.5	
On time of niccup mode		$V_{OUT} = 5V$, $V_{BUS} > 2V$, OC, $T_{J} = -40$ °C to +125°C	3	5	7	
Off time of hiccup mode	T _{HICP_OFF}	$V_{OUT} = 5V$, V_{BUS} connected to GND, $T_{J} = +25$ °C	0.35	0.5	0.65	- s
		Vout = 5V, VBUS connected to GND, TJ = -40°C to +125°C	0.2	0.5	0.8	
BC1.2 DCP Mode						
DP and DM short resistance	R _{DP/DM_Short}	$V_{DP} = 0.8V$, $I_{DM} = 1mA$, $T_{J} = +25$ °C		125	155	Ω
		$V_{DP} = 0.8V$, $I_{DM} = 1mA$, $T_{J} = -40$ °C to $+125$ °C		125	160	
Divider Mode	•			-		•
DD/DM - to t	VDP/DM_Divider	V _{OUT} = 5V, T _J = +25°C	2.54	2.7	2.82	V
DP/DM output voltage		V _{OUT} = 5V, T _J = -40°C to +125°C	2.5	2.7	2.85	
DP/DM output impodence	R _{DP/DM_Divider}	T _J = +25°C	16	22	30	kΩ
DP/DM output impedance		$T_J = -40^{\circ}\text{C to } +125^{\circ}\text{C}$	14	22	34	



ELECTRICAL CHARACTERISTICS (continued) $V_{IN} = 12V$, $V_{EN} = 5V$, $T_J = -40$ °C to +125°C, typical value is tested at $T_J = +25$ °C, unless otherwise noted.

Parameter	Symbol	Condition	Min	Тур	Max	Units
1.2V/1.2V Mode						
DP/DM output voltage	V _{DP/DM_1.2V}	V _{OUT} = 5V, T _J = +25°C	1.16	1.25	1.34	V
		$V_{OUT} = 5V$, $T_J = -40^{\circ}C$ to $+125^{\circ}C$	1.15	1.25	1.35	
DP/DM output impedance	R _{DP/DM_1.2V}	T _J = +25°C	55	68	80	kΩ
		T _J = -40°C to +125°C	50	68	93	

NOTE:

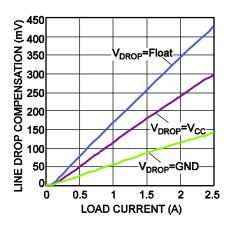
⁶⁾ Guaranteed by design.



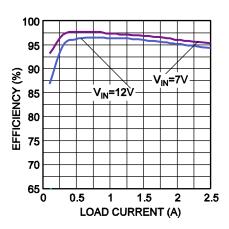
TYPICAL PERFORMANCE CHARACTERISTICS

 V_{IN} = 12V, V_{OUT} = 5V, L = 22 μ H, f_{SW} = 250kHz, T_A = 25°C, unless otherwise noted.

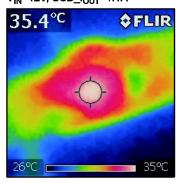
Line Drop Compensation vs. Load Current



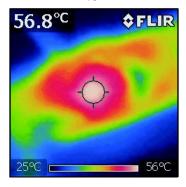
Efficiency vs. Load Current



Thermal Test 2 Layer PCB, 4.78cm x 1.38cm T_A=25°C, No Airflow V_{IN}=12V, USB_I_{OUT}=1.1A



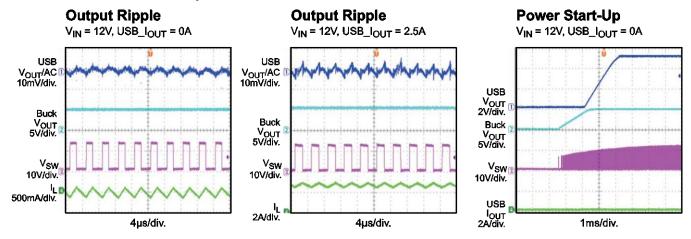
Thermal Test2 Layer PCB, 4.78cm x 1.38cm
T_A=25°C, No Airflow
V_{IN}=12V, USB_I_{OUT}=2.5A

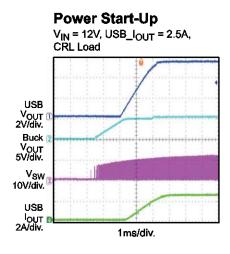


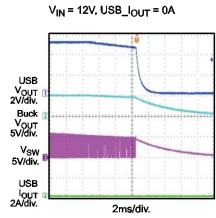


TYPICAL PERFORMANCE CHARACTERISTICS (continued)

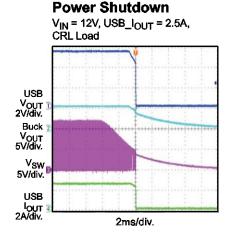
 V_{IN} = 12V, V_{OUT} = 5V, L = 22 μ H, f_{SW} = 250kHz, T_A = 25°C, unless otherwise noted.



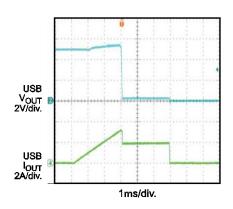




Power Shutdown



USB Over-Current Protection





PIN FUNCTIONS

Name	Description				
DM	D- data line to the USB connector. DM is the input/output used for handshaking with portable devices.				
USB	USB output.				
OUT	Buck output. OUT is the power input of the USB. The internal circuit senses the OUT voltage and regulates it at 5V.				
IN	Supply voltage. IN is the drain of the internal power device and supplies power to the entire chip. The MPQ4475 operates from a 7 - 36V input voltage range. A capacitor (C_{IN}) is needed to prevent large voltage spikes at the input. Place C_{IN} as close to the IC as possible.				
PGND	Power ground. PGND is the reference ground of the regulated output voltage and requires extra care during the PCB layout. Connect PGND to GND with copper traces and vias.				
FREQ	Frequency selection. Float FREQ to set the frequency at 150kHz. Pull FREQ to ground to set the frequency at 250kHz. Pull FREQ high to set the frequency at 350kHz.				
EN	On/off control input.				
SW	Switch output. Connect SW using wide PCB traces.				
BST	Bootstrap. Connect a 0.1µF capacitor between SW and BST to form a floating supply across the high-side switch driver.				
NC	No connection. NC (pin 15) can be connected to OUT for better thermal dissipation.				
AGND	Analog ground. Connect AGND to PGND.				
VCC	Internal 5V LDO regulator output. Decouple VCC with a 0.22µF capacitor.				
VDROP	Line drop compensation selection. Refer to the EC table on page 5 for detailed specifications.				
NC	No connection. NC (pin 20, 21) must be left floating.				
DP	D+ data line to the USB connector. DP is the input/output used for handshaking with portable devices.				
	DM USB OUT IN PGND FREQ EN SW BST NC AGND VCC VDROP NC				



BLOCK DIAGRAM

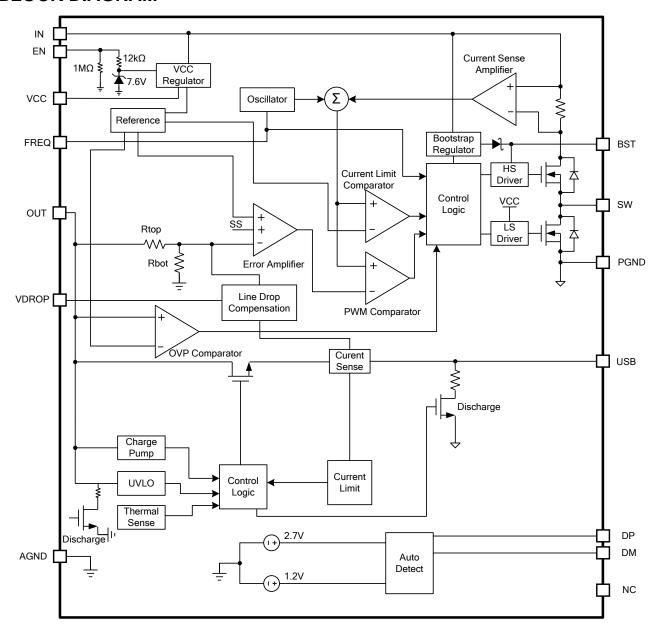


Figure 1: Functional Block Diagram



OPERATION BUCK CONVERTER SECTION

The MPQ4475 integrates a monolithic, synchronous, rectified, step-down, switch-mode converter with internal power MOSFETs and a USB current-limit switch with charging port auto-detection. The MPQ4475 offers a very compact solution that achieves 2.5A of continuous output current with excellent load and line regulation over a wide input supply range.

The MPQ4475 operates in a fixed-frequency, peak-current-mode control to regulate the output voltage. The internal clock initiates the pulse-width modulation (PWM) cycle, which turns on the integrated high-side power MOSFET (HS-FET). The HS-FET turns on and remains on until its current reaches the value set by the COMP voltage (V_{COMP}). If the power switch is off, it remains off until the next clock cycle begins. If the duty cycle reaches 88% (350kHz switching frequency) in one PWM period, the current in the power MOSFET cannot reach the value set by V_{COMP} , and the power MOSFET turns off.

Error Amplifier (EA)

The error amplifier (EA) compares the internal feedback voltage (V_{FB}) against the internal 1V reference (REF) and outputs a V_{COMP} value, which controls the power MOSFET current. The optimized internal compensation network minimizes the external component count and simplifies the control loop design.

Internal VCC Regulator

The 5V internal regulator powers most of the internal circuitries. This regulator takes the V_{IN} input and operates in the full V_{IN} range. When V_{IN} is greater than 5.0V, the output of the regulator is in full regulation. When V_{IN} is lower than 5.0V, the output voltage decreases with V_{IN} . VCC requires an external 0.22 μ F ceramic capacitor for decoupling.

Enable Control (EN)

The MPQ4475 has an enable control pin (EN). Pull EN high to enable the IC. Pull EN low to disable the IC. Connect EN to V_{IN} through a resistor for automatic start-up. An internal $1\text{M}\Omega$ resistor connected from EN to GND allows EN to be floated to shut down the IC. EN is

clamped internally using a 7.6V series Zener diode (see Figure 2). Connecting the EN input through a pull-up resistor to any voltage on V_{IN} limits the EN input current below 230 μ A and the amplitude of the voltage source below 10V to prevent damage to the Zener diode. For example, if 36V is connected to V_{IN} , then $R_{PULLUP} \geq (36V - 10V) / 230 \mu A = 113k\Omega$.

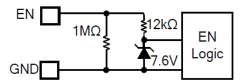


Figure 2: Zener Diode between EN and GND

Under-Voltage Lockout (UVLO)

Under-voltage lockout (UVLO) protects the chip from operating with an insufficient supply voltage. The UVLO comparator monitors the input voltage. The UVLO rising threshold is 5.7V, and its falling threshold is 4.7V.

Internal Soft Start (SS)

Soft start prevents the converter output voltage from overshooting during start-up. When the chip starts up, the internal circuitry generates a soft-start voltage (SS) that ramps up from 0V to 5V. When SS is lower than REF, the error amplifier uses SS as the reference. When SS is higher than REF, the error amplifier uses REF as the reference. The SS time is set to 1.65ms internally.

If the output of the MPQ4475 is pre-biased to a certain voltage during start-up, the IC disables the switching of both the high-side and low-side switches until the voltage on the internal soft-start capacitor exceeds the internal feedback voltage.

Buck Over-Current-Protection (OCP)

The MPQ4475 uses a cycle-by-cycle over-current limit when the inductor peak current exceeds the current-limit threshold, and V_{FB} drops below the under-voltage (UV) threshold (typically 70% below the reference). Once UV is triggered, the MPQ4475 enters hiccup mode to restart the part periodically. This protection mode is especially useful when the output is dead-shorted to ground. The average short-circuit current is reduced greatly to alleviate

thermal issues and protect the regulator. The MPQ4475 exits hiccup mode once the overcurrent condition is removed.

Buck Output Over-Voltage Protection (OVP)

The MPQ4475 buck converter has output overvoltage protection (OVP). If the output is higher than 6V, the high-side switch stops turning on, and the low-side switch turns on to discharge the output voltage until the output decreases to 5.75V. The chip then resumes normal operation.

If the output over-voltage cannot be discharged to 5.75V, the low-side switch is turned off after the inductor current reaches a negative current limit. The low-side switch turns on again when the next clock cycle is triggered.

Floating Driver and Bootstrap Charging

An external bootstrap capacitor powers the floating power MOSFET driver. This floating driver has its own UVLO protection. The UVLO's rising threshold is 2.2V with a hysteresis of 150mV. The bootstrap capacitor voltage is regulated internally by V_{IN} through D1, M1, C4, L1, and C2 (see Figure 3). If V_{BST} - V_{SW} exceeds 5V, U1 regulates M1 to maintain a 5V BST voltage across C4.

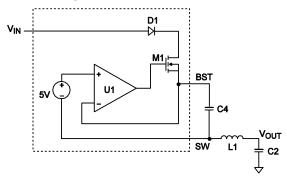


Figure 3: Internal Bootstrap Charging Circuit

Start-Up and Shutdown

If both V_{IN} and EN exceed their respective thresholds, the chip is enabled. The reference block starts first, generating a stable reference voltage and current, and then the internal regulator is enabled. The regulator provides a stable supply for the remaining circuitries.

Three events can shut down the chip: EN low, V_{IN} low, and thermal shutdown. During the shutdown procedure, the signaling path is blocked first to avoid any fault triggering. V_{COMP} and the internal supply rail are then pulled down. The floating driver is not subject to this shutdown command.

Buck Output Discharge

The buck portion involves a discharge function that provides a resistive discharge path for the external output capacitor. This function is active when the part is disabled (input voltage is under UVLO, enable off) and is done in a very limited amount of time. After VCC is discharged below 1V, the buck output discharge resistor is disconnected.



USB CURRENT-LIMIT SWITCH SECTION Current-Limit Switch

The MPQ4475 integrates a single-channel USB current-limit switch. The switch provides built-in, soft-start circuitry that controls the rising slew rate of the output voltage to limit inrush current and voltage surges.

When the load current reaches the current-limit threshold (typically 2.75A), the USB power MOSFET switches into foldback current limit mode (70% of the current limit) (see Figure 4). If the over-current limit condition lasts longer than 3ms, the device enters hiccup mode with 3ms of on time and 0.5s of off time.

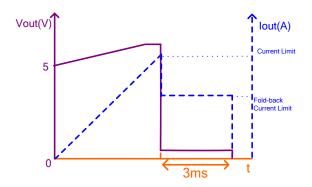


Figure 4: Over-Current Limit

Output Line Drop Compensation

The MPQ4475 can compensate for an outputvoltage drop, such as high impedance caused by a long trace, to maintain a fairly constant 5V load-side voltage.

The MPQ4475 uses the internal current-sense output voltage of the current-limit switch to compensate for the line drop voltage. Since the trace resistance is different for different cables, the MPQ4475 provides selectable line drop compensation through VDROP. The line drop compensation amplitude increases linearly as the load current increases and also has an upper limitation.

USB Output Over-Voltage Protection (OVP)

To protect the device at the cable terminal, the USB switch output uses a dynamic over-voltage protection (OVP) threshold. The MPQ4475 adjusts the OVP threshold based on different USB loading currents.

The MPQ4475 uses intelligent line drop compensation and a dynamic OVP control scheme to ensure that the voltage at the cable terminal meets the 4.75 - 5.25V specification.

USB Output Discharge

The USB portion involves a discharge function that provides a resistive discharge path for the external output capacitor. The function is active when the part is disabled (input voltage is under UVLO, enable off) and is done in a very limited amount of time.

Auto-Detection

The MPQ4475 integrates a USB-dedicated charging port auto-detect function that can recognize most mainstream portable devices. It supports the following charging schemes:

- USB battery charging specification BC1.2/ Chinese Telecommunications Industry Standard YD/T 1591-2009
- Divider mode
- 1.2V/1.2V mode

The auto-detect function utilizes a state machine that supports all of the DCP charging schemes above.

After the power start-up, the MPQ4475 enters default divider mode. The output voltage is 5.05V with full line drop compensation. If MPQ4475 enters BC1.2 short mode or 1.2V/1.2V mode, the output voltage changes to 5.25V with half line drop compensation. By doing this, the device uses BC1.2 mode or 1.2V/1.2V mode, which can charge at its full rated current.

Thermal Shutdown

Thermal shutdown prevents the chip from operating at exceedingly high temperatures. When the silicon die temperature exceeds 165°C, the entire chip shuts down. When the temperature falls below its lower threshold (typically 145°C), the chip is enabled again.

APPLICATION INFORMATION

Selecting the Inductor

For most applications, use an inductor with a DC current rating at least 25% higher than the maximum load current. Select an inductor with a small DC resistance for optimum efficiency. For most designs, the inductor value can be derived with Equation (1):

$$L_{1} = \frac{V_{OUT} \times (V_{IN} - V_{OUT})}{V_{IN} \times \Delta I_{L} \times f_{OSC}}$$
(1)

Where ΔI_{L} is the inductor ripple current.

Choose the inductor ripple current to be approximately 30% of the maximum load current. The maximum inductor peak current can be calculated with Equation (2):

$$I_{L(MAX)} = I_{LOAD} + \frac{\Delta I_{L}}{2}$$
 (2)

A 22µH inductance is recommended to improve EMI.

Selecting the Buck Input Capacitor

The input current to the step-down converter is discontinuous and therefore requires to capacitor supply AC current maintaining the DC input voltage. For the best performance, use low ESR capacitors. Ceramic capacitors with X5R or X7R dielectrics are highly recommended because of their low ESR and small temperature coefficients. For CLA applications, a low ESR 100µF electrolytic capacitor and two 10µF ceramic capacitors are recommended for EMI reduction.

Since the input capacitor (C1) absorbs the input switching current, it requires an adequate ripple current rating. The RMS current in the input capacitor can be estimated with Equation (3):

$$I_{C1} = I_{LOAD} \times \sqrt{\frac{V_{OUT}}{V_{IN}}} \times \left(1 - \frac{V_{OUT}}{V_{IN}}\right)$$
 (3)

The worst-case condition occurs at $V_{IN} = 2V_{OUT}$, shown in Equation (4):

$$I_{C1} = \frac{I_{LOAD}}{2} \tag{4}$$

For simplification, choose an input capacitor with an RMS current rating greater than half of the maximum load current. The input capacitor can be electrolytic, tantalum, or ceramic. When using electrolytic capacitors, add two high-quality ceramic capacitors as close to IN as possible. The input voltage ripple caused by the capacitance can be estimated with Equation (5):

$$\Delta V_{IN} = \frac{I_{LOAD}}{f_{S} \times C1} \times \frac{V_{OUT}}{V_{IN}} \times \left(1 - \frac{V_{OUT}}{V_{IN}}\right)$$
 (5)

Selecting the Buck Output Capacitor

The device requires an output capacitor (C2) to maintain the DC output voltage. Estimate the output voltage ripple with Equation (6):

$$\Delta V_{\text{OUT}} = \frac{V_{\text{OUT}}}{f_{\text{S}} \times L_{1}} \times \left(1 - \frac{V_{\text{OUT}}}{V_{\text{IN}}}\right) \times \left(R_{\text{ESR}} + \frac{1}{8 \times f_{\text{S}} \times C2}\right)$$
 (6)

Where L_1 is the inductor value, and RESR is the equivalent series resistance (ESR) value of the output capacitor.

For electrolytic capacitors, the ESR dominates the impedance at the switching frequency. For simplification, the output ripple can be approximated with Equation (7):

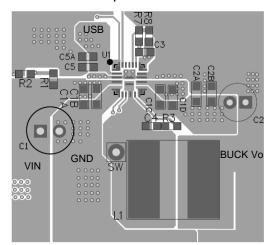
$$\Delta V_{\text{OUT}} = \frac{V_{\text{OUT}}}{f_{\text{S}} \times L_{1}} \times \left(1 - \frac{V_{\text{OUT}}}{V_{\text{IN}}}\right) \times R_{\text{ESR}}$$
 (7)

The characteristics of the output capacitor affect the stability of the regulatory system. A low ESR electrolytic capacitor is recommended for low output ripple and good control loop stability. For CLA applications, a 1µF ceramic capacitor and a 270µF polymer or electrolytic capacitor with ~20m Ω ESR are recommended.

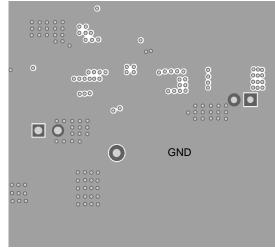
PCB Layout Guidelines

Efficient PCB layout is critical for stable operation and thermal dissipation. For best results, refer to Figure 5 and follow the guidelines below.

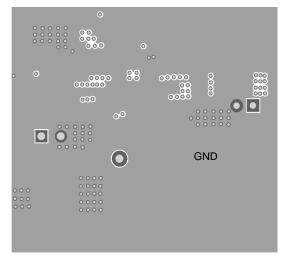
- Connect OUT with short, direct, and wide traces.
- 2. Add vias under the IC.
- 3. Route the OUT trace on both PCB layers.
- 4. Use a large copper plane for PGND.
- 5. Add multiple vias for better thermal dissipation.
- 6. Connect AGND to PGND.
- 7. Use a large copper plane for SW and USB.
- 8. Place the USB output capacitor close to USB.
- 9. Place two ceramic input decoupling capacitors as close to IN and PGND as possible to improve EMI performance.
- 10. Place the VCC decoupling capacitor as close to VCC as possible.



Top Layer



Mid Layer 1



Mid Layer 2

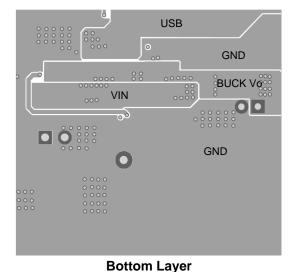


Figure 5: Recommended Layout



TYPICAL APPLICATION CIRCUIT

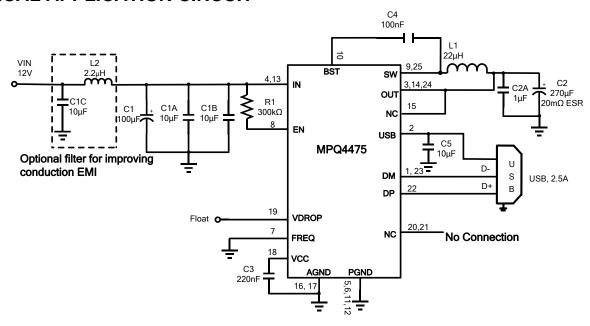
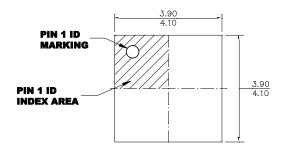


Figure 6: $V_{IN} = 12V$, USB = 5V/2.5A

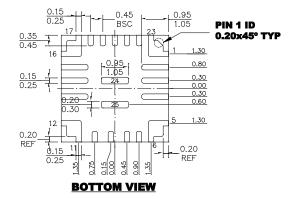


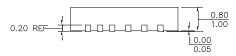
PACKAGE INFORMATION

QFN-25 (4mmx4mm)

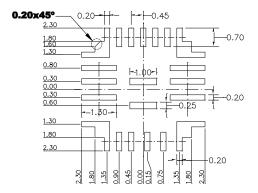


TOP VIEW





SIDE VIEW



RECOMMENDED LAND PATTERN

NOTE:

- 1) LAND PATTERN OF PIN2~4 AND 13~15 HAVE THE SAME LENGTH AND WIDTH.
- 2) LAND PATTERN OF PIN24 AND 25 HAVE THE SAME LENGTH AND WIDTH.
- 2) ALL DIMENSIONS ARE IN MILLIMETERS.
- 2) LEAD COPLANARITY SHALL BE 0.10 MILLIMETERS MAX.
- 3) JEDEC REFERENCE IS MO-220.
- 4) DRAWING IS NOT TO SCALE.

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